



40V N-Channel SGT Power MOSFET

General Description

The SJM040N04 uses SGT technology to provide excellent $R_{DS(ON)}$, low gate charge and fast switching characteristics. This device is suitable for use as a wide variety of applications.

Features

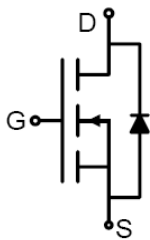
- Low Gate Charge
- 100% UIS Tested, 100% DVDS Tested
- High Power and current handling capability
- Lead free product is acquired

Application

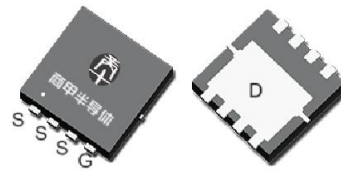
- DC/DC Converter
- Load Switching, Quick/Wireless Charging, Motor Driving

Key Performance Parametes

| Parameter | Value | Unit |
|-------------------|-------|------------|
| V_{DS} | 40 | V |
| $R_{DS(ON_TYP)}$ | 5.2 | m Ω |
| I_D | 72 | A |
| Q_G | 22.7 | nC |



Schematic Diagram



PDFN3X3-8L top&bottom view



Package Marking and Ordering Information

| Device/Ordering Code | Marking | Package | Packing | Reel Size | Tape width | Quantity |
|----------------------|-----------|------------|---------|-----------|------------|----------|
| SJM040N04 | SJM040N04 | PDFN3X3-8L | Tape | \ | \ | 5000 Pcs |

Table 1. Absolute Maximum Ratings ($T_C=25^\circ\text{C}$ unless otherwise noted)

| Symbol | Parameter | Limit | Unit |
|------------------------|--|------------|------------------|
| V_{DS} | Drain-Source Voltage ($V_{GS}=0V$) | 40 | V |
| V_{GS} | Gate-Source Voltage ($V_{DS}=0V$) | ± 20 | V |
| I_D | Drain Current-Continuous($T_C=25^\circ\text{C}$) | 72 | A |
| | Drain Current-Continuous($T_C=100^\circ\text{C}$) | 45 | A |
| $I_{DM}(\text{pluse})$ | Drain Current-Continuous@ Current-Pulsed (Note 1) | 288 | A |
| P_D | Maximum Power Dissipation($T_C=25^\circ\text{C}$) | 59 | W |
| | Maximum Power Dissipation($T_C=100^\circ\text{C}$) | 23 | W |
| E_{AS} | Avalanche energy (Note 2) | 100 | mJ |
| T_J, T_{STG} | Operating Junction and Storage Temperature Range | -55 To 150 | $^\circ\text{C}$ |

Table 2. Thermal Characteristic

| Symbol | Parameter | Typ | Max | Unit |
|-----------------|--------------------------------------|-----|------|--------------------|
| $R_{\theta JC}$ | Thermal Resistance, Junction-to-Case | | 2.13 | $^\circ\text{C/W}$ |



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Table 3. Electrical Characteristics ($T_J=25^{\circ}\text{C}$ unless otherwise noted)

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit | |
|------------------------------------|--|--|-----|------|------|------|----|
| On/Off States | | | | | | | |
| BV _{DSS} | Drain-Source Breakdown Voltage | V _{GS} =0V I _D =250μA | 40 | | | V | |
| I _{DSS} | Zero Gate Voltage Drain Current | V _{DS} =40V, V _{GS} =0V T _J =25℃ | | | 1 | μA | |
| | | V _{DS} =40V, V _{GS} =0V T _J =125℃ | | | 100 | μA | |
| I _{GSS} | Gate-Body Leakage Current | V _{GS} =±20V, V _{DS} =0V | | | ±100 | nA | |
| V _{GS(th)} | Gate Threshold Voltage | V _{DS} =V _{GS} , I _D =250μA | 1 | | 2.5 | V | |
| g _{FS} | Forward Transconductance | V _{DS} =5V, I _D =20A | | 49 | | S | |
| R _{DS(ON)} | Drain-Source On-State Resistance | V _{GS} =10V, I _D =20A T _J =25℃ | | 5.2 | 6.8 | mΩ | |
| Dynamic Characteristics | | | | | | | |
| C _{iss} | Input Capacitance | V _{DS} =20V, V _{GS} =0V, f=1.0MHz | | 1105 | | pF | |
| C _{oss} | Output Capacitance | | | | 246 | | pF |
| C _{rss} | Reverse Transfer Capacitance | | | | 30.7 | | pF |
| R _g | Gate resistance | V _{GS} =0V, V _{DS} =0V, f=1.0MHz | | 1.4 | | Ω | |
| Switching Parameters | | | | | | | |
| t _{d(on)} | Turn-on Delay Time | V _{GS} =10V, V _{DS} =20V, R _L =1Ω, R _{GEN} =3Ω | | 9.2 | | nS | |
| t _r | Turn-on Rise Time | | | | 23 | | nS |
| t _{d(off)} | Turn-Off Delay Time | | | | 25.6 | | nS |
| t _f | Turn-Off Fall Time | | | | 6 | | nS |
| Q _g | Total Gate Charge | V _{GS} =10V, V _{DS} =20V, I _D =20A | | 22.7 | | nC | |
| Q _{gs} | Gate-Source Charge | | | | 3.84 | | nC |
| Q _{gd} | Gate-Drain Charge | | | | 4.8 | | nC |
| Source-Drain Diode Characteristics | | | | | | | |
| I _{SD} | Source-Drain Current (Body Diode) | | | | 72 | A | |
| V _{SD} | Forward on Voltage ^(Note 3) | V _{GS} =0V, I _S =20A | | | 1.2 | V | |
| t _{rr} | Reverse Recovery Time | I _F =20A, dI/dt=100A/μs | | 19.9 | | ns | |
| Q _{rr} | Reverse Recovery Charge | I _F =20A, dI/dt=100A/μs | | 12.9 | | nC | |

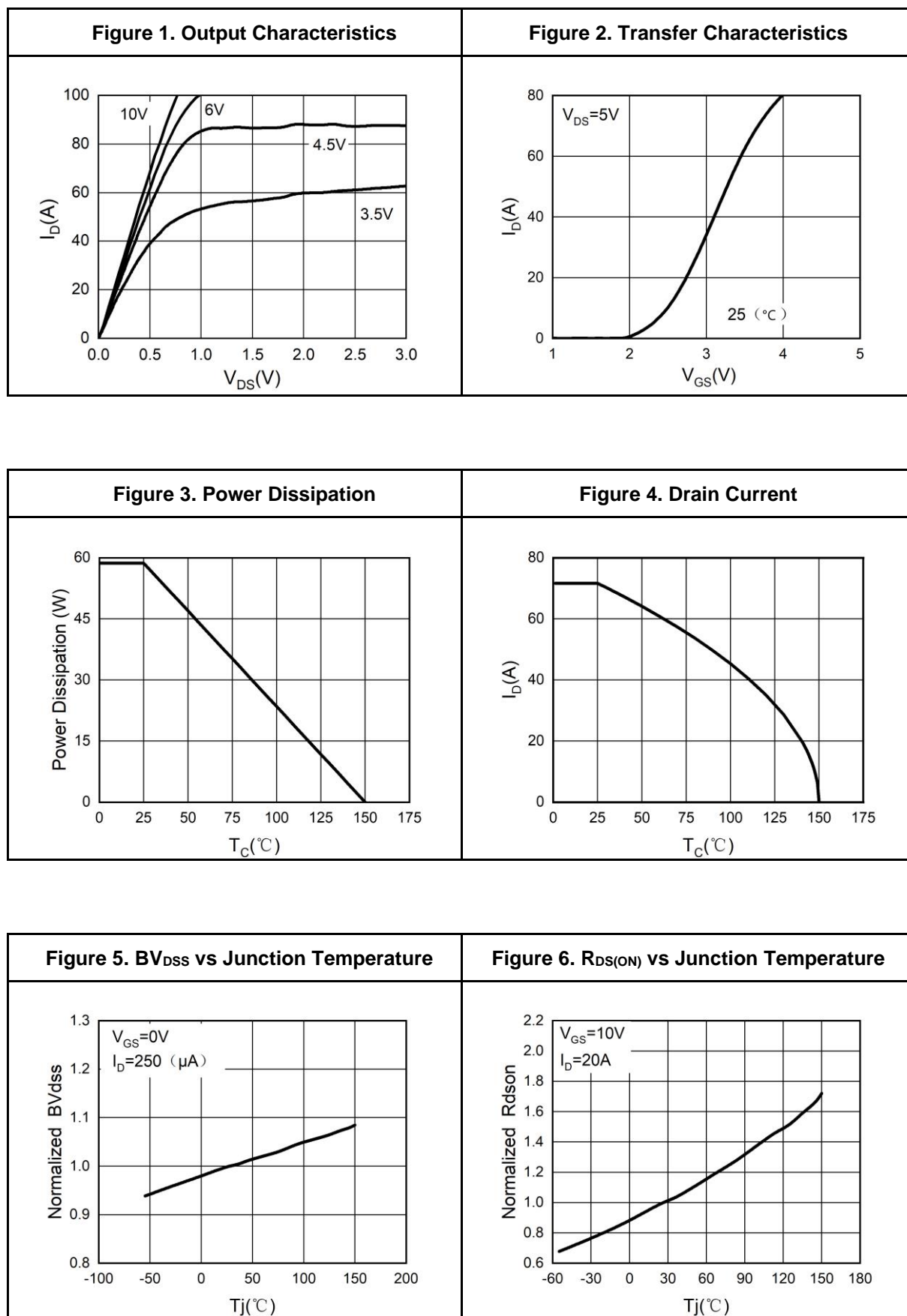
Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

Notes 2.EAS condition: $T_J=25^{\circ}\text{C}, V_{DD}=40V, V_G=10V, R_g=25\Omega, L=0.5\text{mH}$.

Notes 3.Repetitive Rating: Pulse width limited by maximum junction temperature.

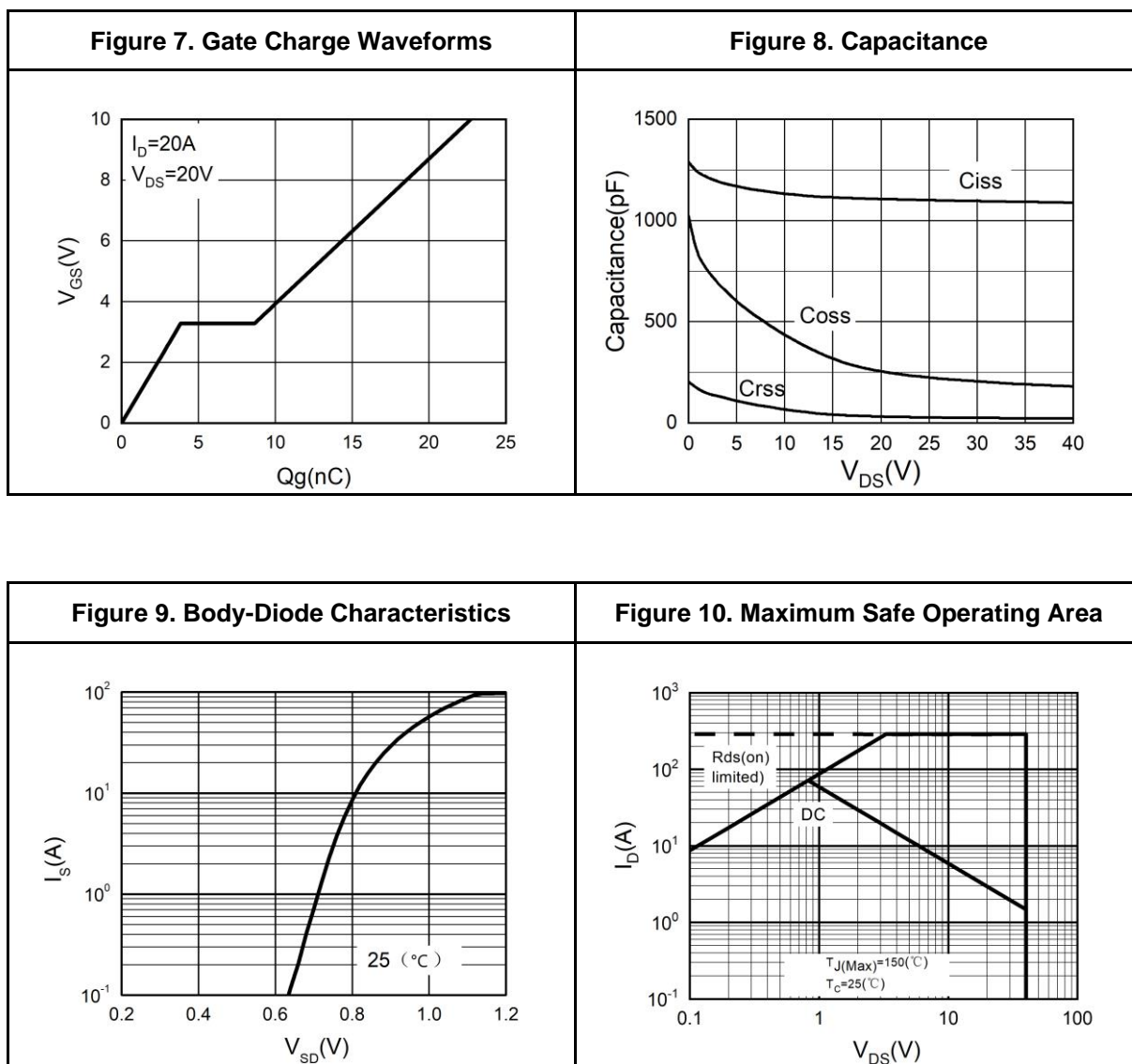


Typical Electrical And Thermal Characteristics (Curves)



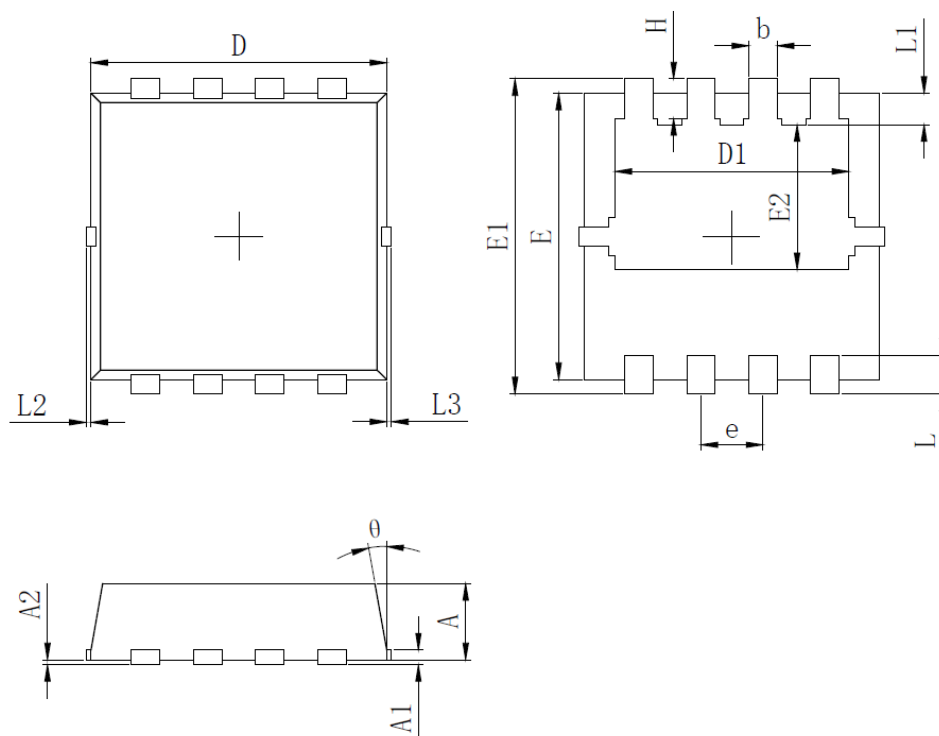


Typical Electrical And Thermal Characteristics (Curves)





PDFN3X3-8L Package Information



| SYMBOL | MILLIMETER | | |
|----------|------------|-------|-------|
| | MIN | Typ. | MAX |
| A | 0.700 | 0.800 | 0.900 |
| A1 | 0.152 REF. | | |
| A2 | 0~0.05 | | |
| D | 3.000 | 3.100 | 3.200 |
| D1 | 2.300 | 2.450 | 2.600 |
| E | 2.900 | 3.000 | 3.100 |
| E1 | 3.150 | 3.300 | 3.450 |
| E2 | 1.320 | 1.520 | 1.720 |
| b | 0.200 | 0.300 | 0.400 |
| e | 0.550 | 0.650 | 0.750 |
| L | 0.300 | 0.400 | 0.500 |
| L1 | 0.180 | 0.330 | 0.480 |
| L2 | 0~0.100 | | |
| L3 | 0~0.100 | | |
| H | 0.315 | 0.415 | 0.515 |
| θ | 8° | 10° | 12° |



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